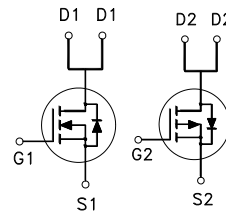




**PRODUCT SUMMARY**

	$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
N-Channel	20V	30mΩ	6A
P-Channel	-20V	75mΩ	-3.8A

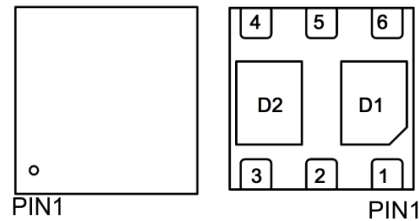


**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

**Applications**

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.
- DC Motor for BLDC Applications.



- 1 : S1.      4 : S2.
  - 2 : G1.      5 : G2.
  - 3 : D2.      6 : D1.
- 100% UIS Tested  
100% Rg Tested

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	N-Channel	P-Channel	UNITS
Drain-Source Voltage		$V_{DS}$	20	-20	V
Gate-Source Voltage		$V_{GS}$	±8	±8	V
Continuous Drain Current	$T_A = 25\text{ °C}$	$I_D$	6	-3.8	A
	$T_A = 70\text{ °C}$		4.8	-3	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	20	-15	
Power Dissipation <sup>3</sup>	$T_A = 25\text{ °C}$	$P_D$	1.9	1.9	W
	$T_A = 70\text{ °C}$		1.2	1.2	
Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150		°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10s$	$R_{\theta JA}$	N-ch	63	°C / W
			P-ch	63	
Junction-to-Ambient <sup>2</sup>	Steady-State		N-ch	97	
			P-ch	97	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25\text{ °C}$ .

<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10s$  value.

**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
<b>STATIC</b>							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	N-Ch	20		V	
		V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	P-Ch	-20			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	N-Ch	0.5	0.7	1	V
		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	P-Ch	-0.3	-0.6	-1	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±8V	N-Ch			±100	nA
		V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±8V	P-Ch			±100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V	N-Ch			1	μA
		V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V	P-Ch			-1	
		V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C	N-Ch			10	
		V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C	P-Ch			-10	
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5A	N-Ch		25	30	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2.5A	P-Ch		60	75	
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 4.5A	N-Ch		29	38	
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2A	P-Ch		73	90	
		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 2A	N-Ch		36	55	
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -1A	P-Ch		91	125	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 5A	N-Ch		26		S
		V <sub>DS</sub> = -10V, I <sub>D</sub> = -2.5A	P-Ch		10		
<b>DYNAMIC</b>							
Input Capacitance	C <sub>iss</sub>	N-Channel V <sub>GS</sub> = 0V, V <sub>DS</sub> = 10V, f = 1MHz	N-Ch		510		pF
Output Capacitance	C <sub>oss</sub>		P-Channel V <sub>GS</sub> = 0V, V <sub>DS</sub> = 10V, f = 1MHz	N-Ch		83	
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -10V, f = 1MHz	P-Ch		82		
			N-Ch		67		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz	P-Ch		61		
			N-Ch		1.9		Ω
			P-Ch		7.4		

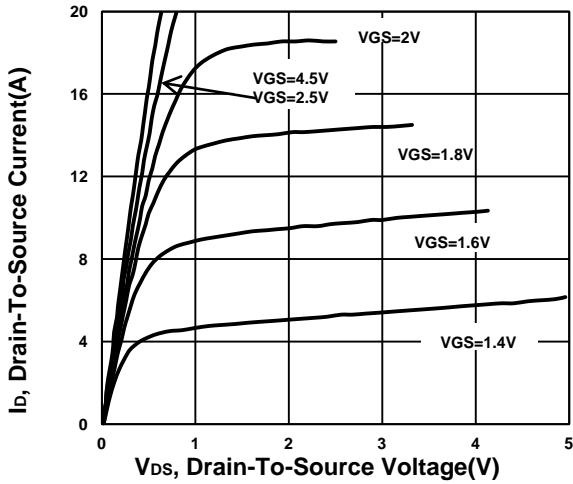
Total Gate Charge <sup>2</sup>	$Q_g$	N-Channel $V_{DS} = 10V, V_{GS} = 4.5V,$ $I_D = 5A$ P-Channel $V_{DS} = -10V, V_{GS} = -4.5V,$ $I_D = -2.5A$	N-Ch		7.3		nC
Gate-Source Charge <sup>2</sup>	$Q_{gs}$		N-Ch		0.6		
Gate-Drain Charge <sup>2</sup>	$Q_{gd}$		P-Ch		0.7		
Turn-On Delay Time <sup>2</sup>	$t_{d(on)}$	N-Channel $V_{DS} = 10V,$ $I_D \cong 5A, V_{GS} = 4.5V, R_{GEN} = 6\Omega$ P-Channel $V_{DS} = -10V,$ $I_D \cong -2.5A, V_{GS} = -4.5V,$ $R_{GEN} = 6\Omega$	N-Ch		11		nS
Rise Time <sup>2</sup>	$t_r$		P-Ch		8.2		
Turn-Off Delay Time <sup>2</sup>	$t_{d(off)}$		N-Ch		94		
Fall Time <sup>2</sup>	$t_f$		P-Ch		33		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>							
Continuous Current	$I_S$		N-Ch			1.9	A
			P-Ch			-1.6	
Forward Voltage <sup>1</sup>	$V_{SD}$		N-Ch			1	V
			P-Ch			-1.2	
Reverse Recovery Time	$t_{rr}$	$I_F = 5A, di_F/dt = 100A / \mu S$	N-Ch			9	nS
			P-Ch			10	
Reverse Recovery Charge	$Q_{rr}$	$I_F = -2.5A, di_F/dt = 100A / \mu S$	N-Ch			3	nC
			P-Ch			3	

<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

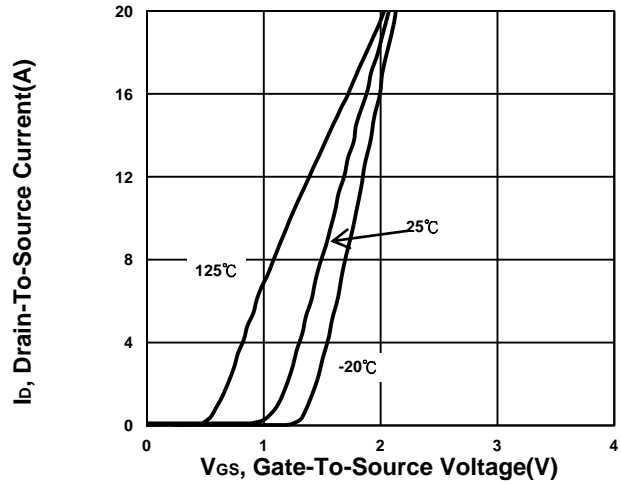
<sup>2</sup>Independent of operating temperature.

**TYPICAL PERFORMANCE CHARACTERISTICS  
N-CHANNEL**

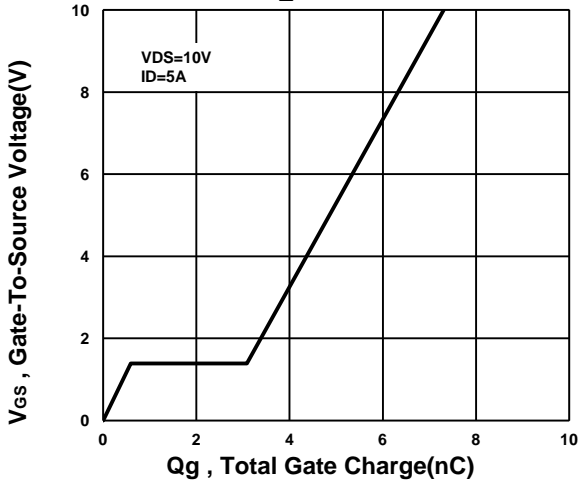
**Output Characteristics**



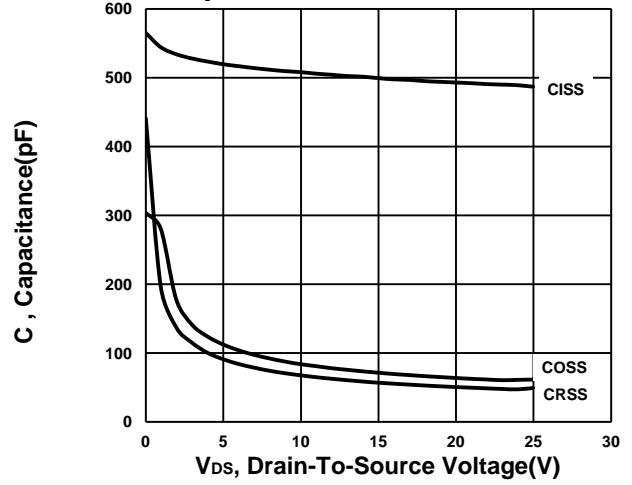
**Transfer Characteristics**



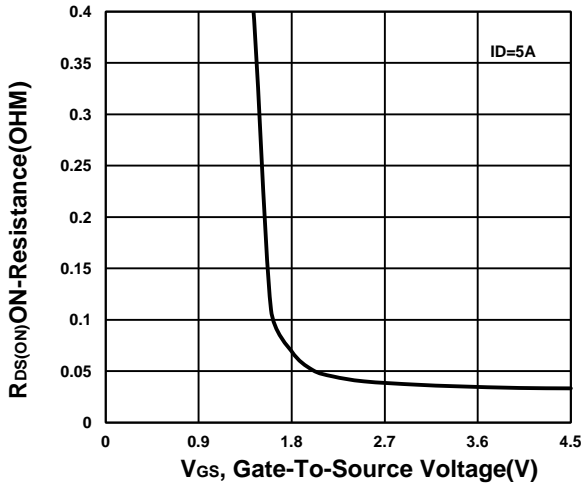
**Gate charge Characteristics**



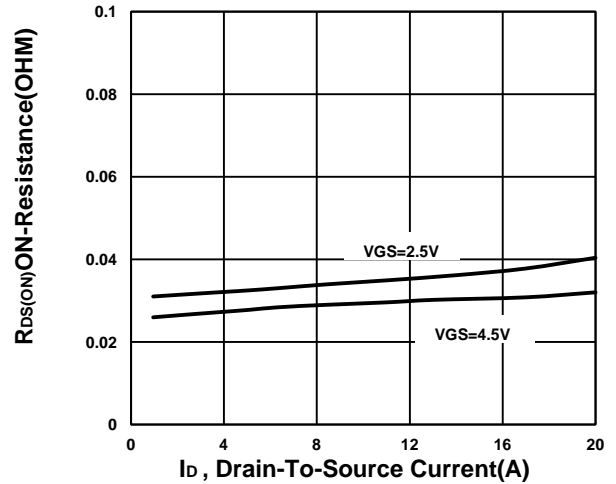
**Capacitance Characteristic**



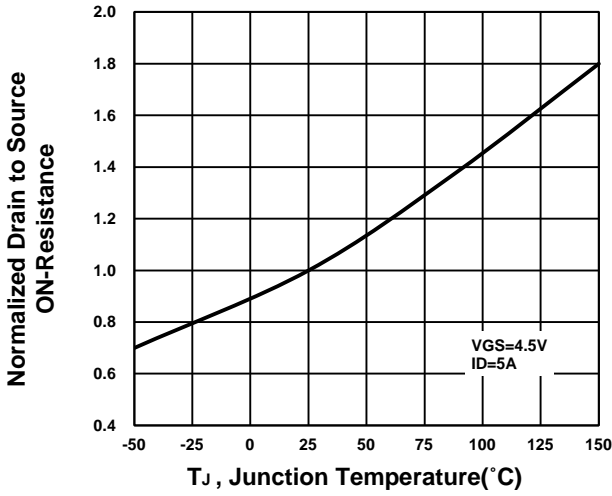
**On-Resistance VS Gate-To-Source Voltage**



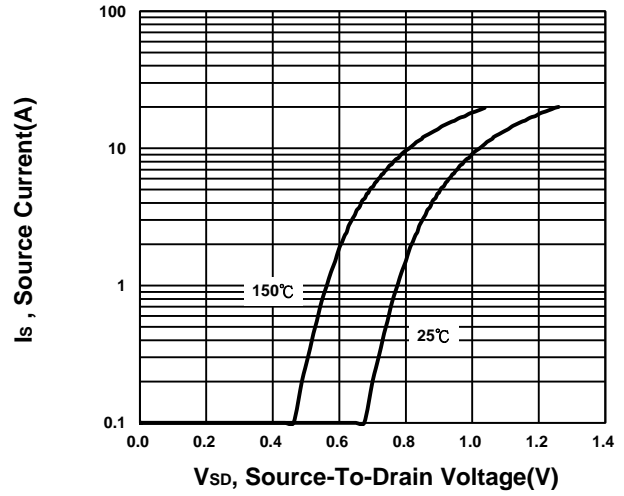
**On-Resistance VS Drain-To-Source Current**



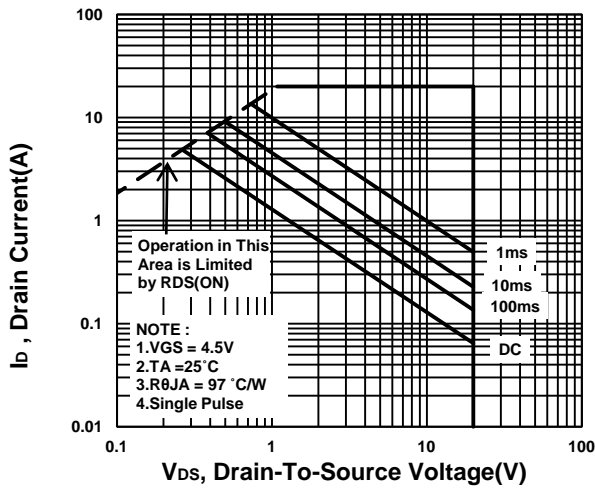
**On-Resistance VS Temperature**



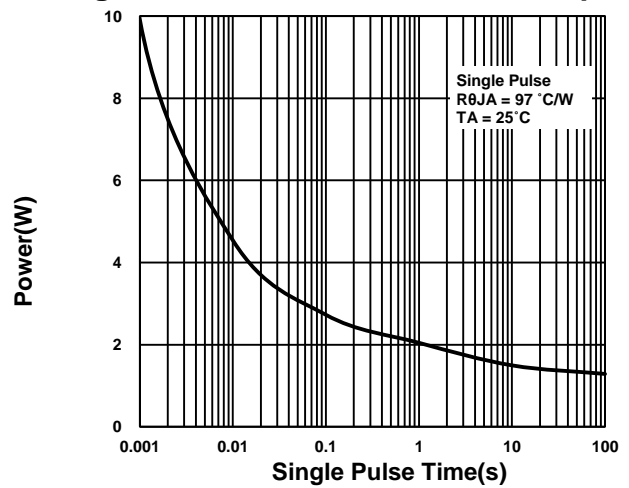
**Source-Drain Diode Forward Voltage**



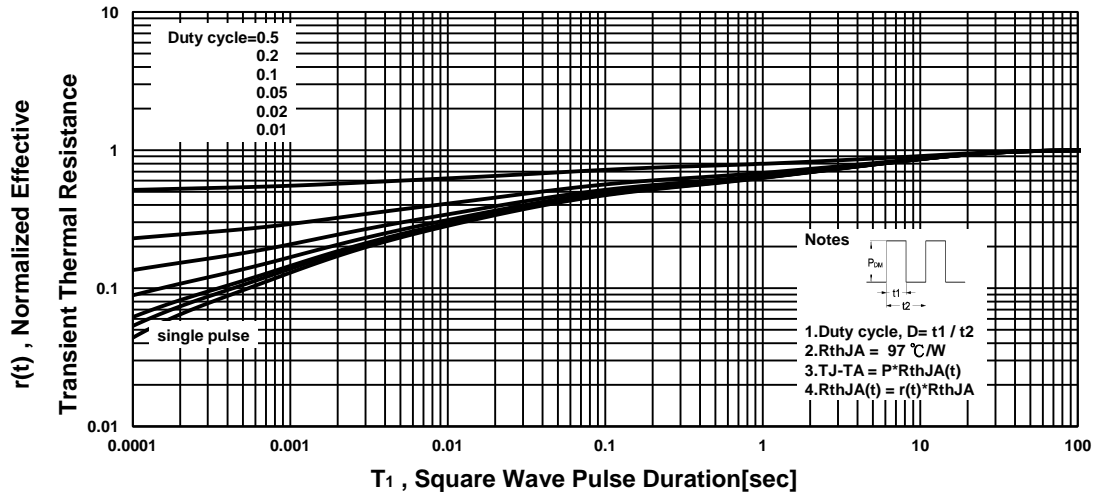
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**

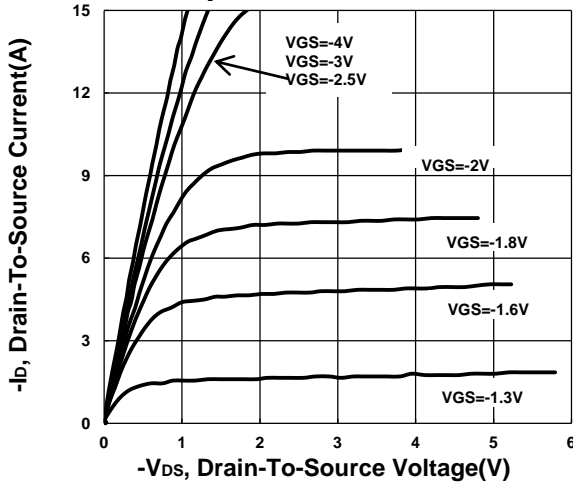


**Transient Thermal Response Curve**

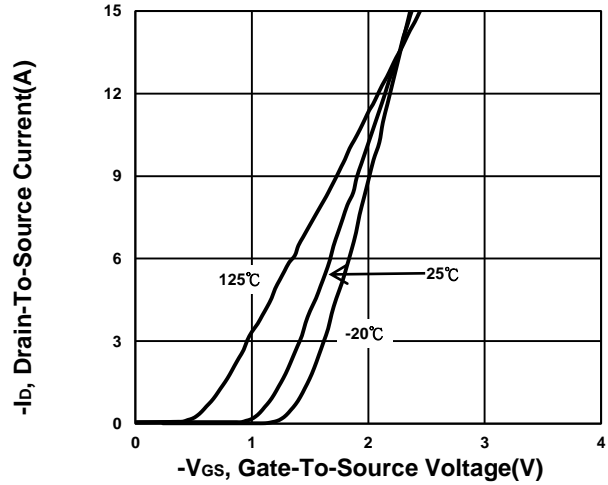


**P-CHANNEL**

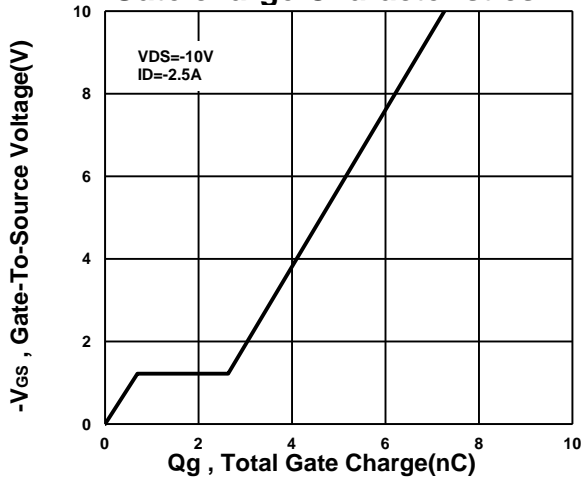
**Output Characteristics**



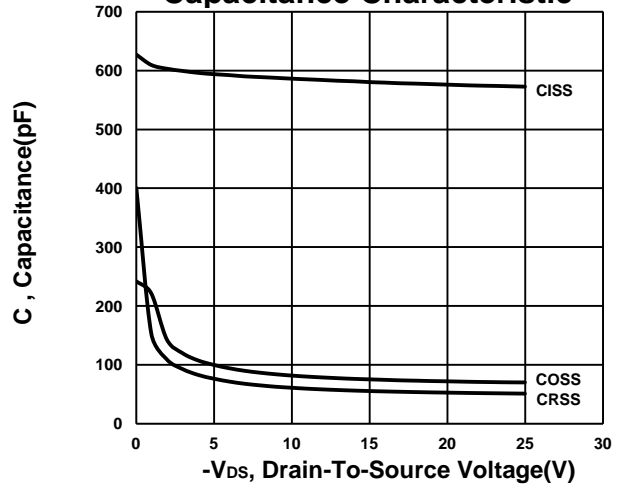
**Transfer Characteristics**



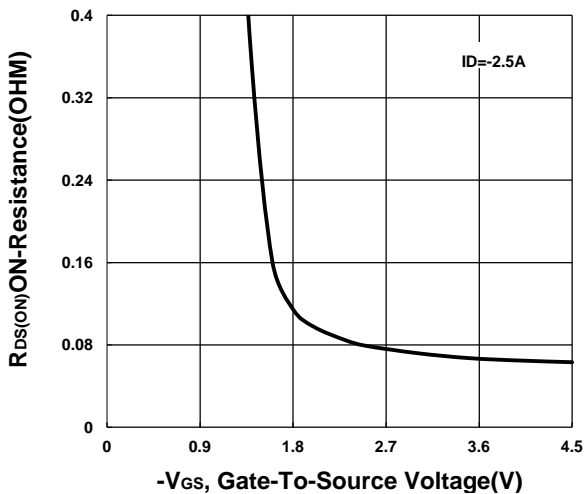
**Gate charge Characteristics**



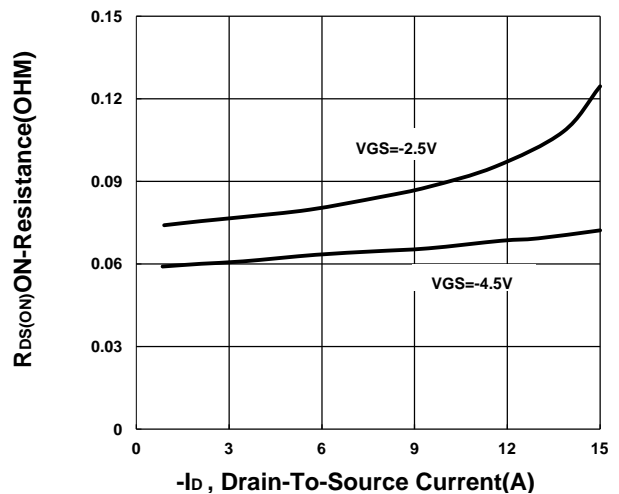
**Capacitance Characteristic**



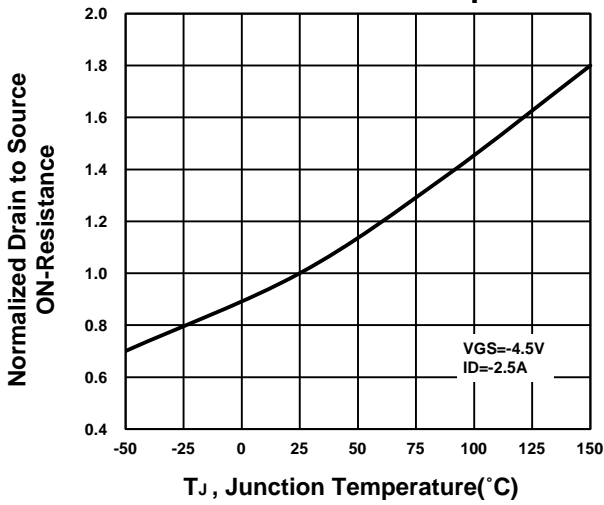
**On-Resistance VS Gate-To-Source Voltage**



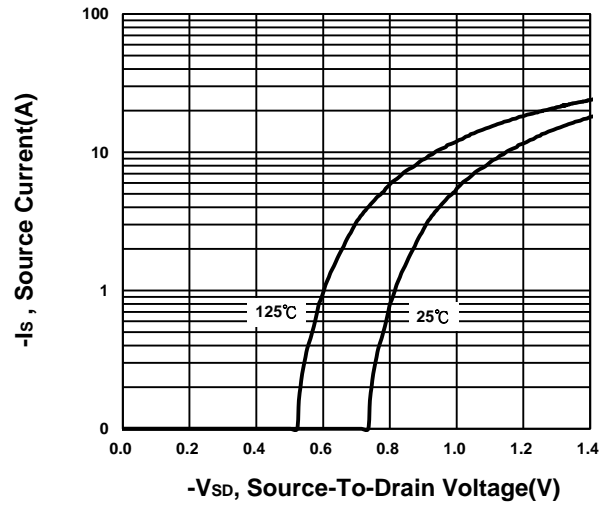
**On-Resistance VS Drain-To-Source Current**



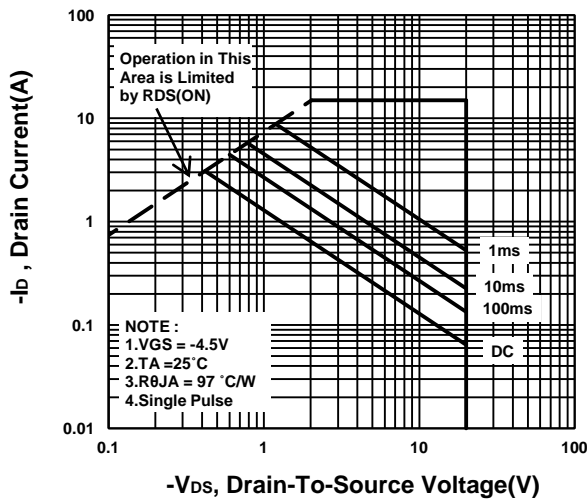
**On-Resistance VS Temperature**



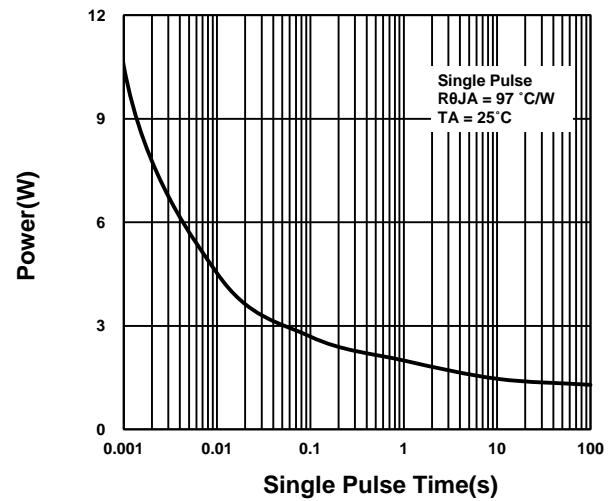
**Source-Drain Diode Forward Voltage**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

